	CONNECTING CONNECTING CONNECTING CONNECTING CONNECTING CONNECTING CONNECTING CONNECTING CONNECTING	PC, Bannockb	urn, Illinois. A	ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a declarat	tion of t encomp	he substances asses all lowe	within the er level mat	manufactur erials for wl	er listed it hich the m	em. Note: nanufacture	if the item is an as er has engineering	ssembly with lowe responsibility.
1752-21.1					Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					eous Materia	als and Mfg Information			
Supplie	r Information														
Company name* Co				Company unique ID			Unique ID Authority					Response Date*			
onsemi												2024-05-18			
Contact N	lame	Title - Contact]	Phone - Contact*					Email - Contact*				
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorize	ed Representative*		Title - Representative]	Phone - Representative*				Email - Representative*				
Product-	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number Mfr Item Name			·	Effective Date	fective Date Version Manufacturing Si		ing Site	1	Weight*	UOM	Unit Type	
		DFB2560		BR TS6P GPPN 25A 600V			2024-05-18 TSC		ISCBE		7	7150.0	mg	Each	
/Ianufa	cturing Proccess Informat	tion						·	1						
	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-020		-STD-020 MSI	L Rating	Peak Process Body Temperat		ure Max Time at Peak Temp		Temperat	ure Num	ber of Reflow Cyc	cles	
	Matte Tin (Sn) - annealed		CU Alloy NA			0 C		30 se		secon	ds 3				
omments	3														
or more	information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declar	ation			Declaration Type *	Detailed
Directive 2015/863/EU amending Rol Directive 2011/65/EU	(Pb), Mercury (Hg), Hexav		ninated Biphenyls (PBB), Polybror	dmium and quantity limit of 0.1% by mass (100 ninated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polyb contains a RoHS restricted substance i encompass all such components.Suppl as of the date that Supplier completes Company acknowledges that Supplier independently verified information pro- certification in this paragraph.If the Co	rominated biphenyls and/or polybror nexcess of an applicable quantity lim ier certifies that it gathered the inforr this form.Supplier acknowledges that may have relied on informationprovi ovided by others, Supplier agrees that ompany and the Supplier enter into a clusivesource of the Supplier's liabili	ninated diphenyl ethers (each a "R it, please indicate below which, if nation it provides in this form usin Company will rely on this certifud ded by others in completing this f , at a minimum, itssuppliers have written agreement with respect to ty and the Company's remedies for	toHS restricted substance") in exce any, RoHS exemption you believe ag appropriate methods to ensure it cation in determining the complian orm, and that Supplier may not hav provided certifications regarding th the identified part, the terms and co or issues that arise regarding inform	ropean Union member states) of the part identifies so of the applicable quantity limit identified about may apply. If the part is an assembly with lows a accuracy and that such information is true and ce of its products with European Union member re independently verified such information. How heir contributions to the part, and those certifica motions of that agreement, including any warra nation the Supplier provides in this form. In the	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the inty rights and/or remedies provided as part of
RoHS Declaration * 4	- Item(s) does not contain RoHS restr	icted substances per the definition	above except for selected exempti	ons Supplier Acceptance	* Accepted
Exemption: 7a: Lead in high meltin Exemption: 7c-I Electrical and elect	g temperature type solders (i.e. lead ronic components containing lead i	l based solder alloys containing n a glass or ceramic other than	85% by weight or more lead). dielectric ceramic in capacitors, o	e.g. piezoelectronic devices, or in a glass or ce	eramic matrix compound.
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the rec Requester) and click on Submit For			Supplier Acceptance drop-down	. This will display the signature area. Digital	ly sign the declaration (if required by the
Supplier Digital Signature	Rastislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	153.725	mg	В	Nickel (Ni)	7440-02-0		0.1537	mg
			Supplier	Iron (Fe)	7439-89-6		0.1537	mg
			Supplier	Copper (Cu)	7440-50-8		153.3714	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0461	mg
Die	42.9	mg	Supplier	Silicon (Si)	7440-21-3		38.61	mg
			В	Nickel (Ni)	7440-02-0		0.2788	mg
			Supplier	Gold (Au)	7440-57-5		0.0644	mg
			Supplier	Lead Bisilicate	65997-18-4	7c	3.9468	mg
Die Attach Solder	10.725	mg	Supplier	Silver (Ag)	7440-22-4		0.2681	mg
			А	Lead (Pb)	7439-92-1	7a	9.9206	mg
			Supplier	Tin (Sn)	7440-31-5		0.5363	mg
Lead Frame	2952.95	mg	Supplier	Iron (Fe)	7439-89-6		2.953	mg
			Supplier	Copper (Cu)	7440-50-8		2949.1111	mg
			Supplier	Phosphorus (P)	7723-14-0		0.8859	mg
Mold Compound-Black	3946.8	mg		Epoxy resin	proprietary data		146.0316	mg
			Supplier	Phenolic Resin	Proprietary Data		146.0316	mg
			Supplier	Carbon Black (C)	1333-86-4		23.6808	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		592.02	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		276.276	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		2762.76	mg
Plating	42.9	mg	Supplier	Tin (Sn)	7440-31-5		42.9	mg